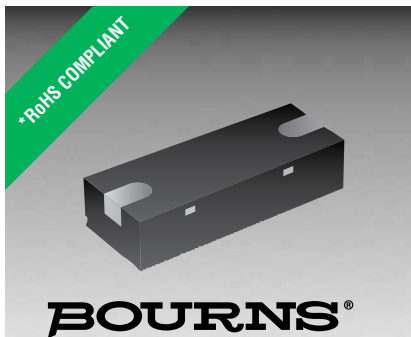




Features

- Bidirectional TVS 5 V
- Low capacitance - 0.5 pF
- ESD protection >15 kV
- Fits 0402 footprint

Applications

- Computers and peripherals
- Communication systems
- Audio & video equipment
- Portable instrumentation

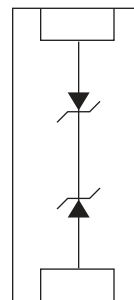
CDDFN2-T5.0LC - Surface Mount TVS Diode

General Information

The Bourns® Model CDDFN2-T5.0LC low capacitance device provides ESD and EFT protection for external ports of electronic devices such as cellular phones, handheld electronics and other portable electronic devices.

The device measures 1.0 mm x 0.60 mm and is available in a DFN-2 package and is intended to be mounted directly onto an FR4 printed circuit board. The device will fit a 0402 footprint.

The device is designed to meet IEC 61000-4-2 (ESD) and IEC 61000-4-4 (EFT) protection requirements.



Absolute Maximum Ratings (@ T_A = 25 °C Unless Otherwise Noted)

Parameter	Symbol	Min.	Typ.	Max.	Unit
Operating Temperature	T _{OPR}	-40	+25	+85	°C
Storage Temperature	T _{STG}	-55	+25	+150	°C

Electrical Characteristics (@ T_A = 25 °C Unless Otherwise Noted)

Parameter	Symbol	Min.	Typ.	Max.	Unit
Working Peak Voltage	V _{WM}			5.0	V
Breakdown Voltage @ 1 mA	V _{BR}	7.0			V
Leakage Current @ 5 V	I _L		0.1	1.0	μA
Capacitance @ 0 V, 1 MHz	C _J		0.50	0.65	pF
Clamping Voltage per IEC 61000-4-2 @ 6 kV Contact Mode	V _C		25		V
ESD Protection per IEC 61000-4-2					
Contact Discharge	ESD	8			kV
Air Discharge	ESD	15			kV
EFT Protection per IEC 61000-4-4	EFT			40	A

BOURNS®

Asia-Pacific: Tel: +886-2 2562-4117 • Fax: +886-2 2562-4116

EMEA: Tel: +36 88 520 390 • Fax: +36 88 520 211

The Americas: Tel: +1-951 781-5500 • Fax: +1-951 781-5700

www.bourns.com

*RoHS Directive 2002/95/EC Jan. 27, 2003 including annex and RoHS Recast 2011/65/EU June 8, 2011.

Specifications are subject to change without notice.

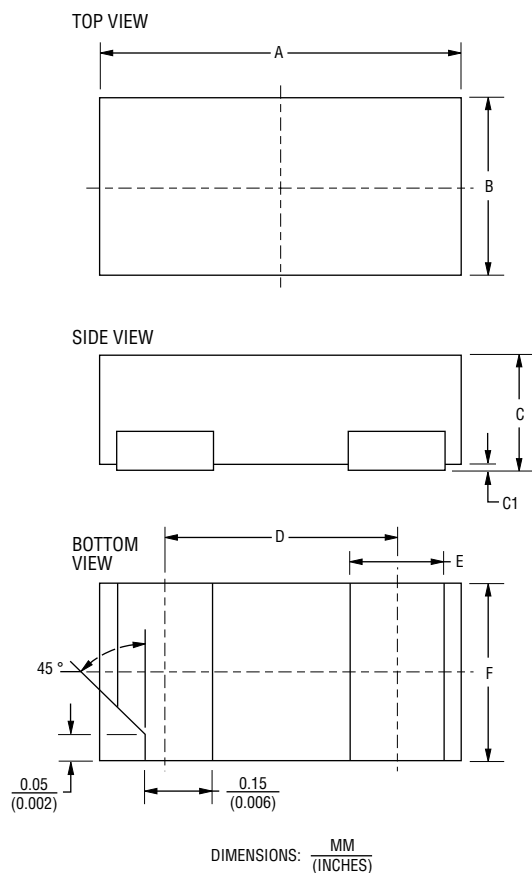
The device characteristics and parameters in this data sheet can and do vary in different applications and actual device performance may vary over time. Users should verify actual device performance in their specific applications.

CDDFN2-T5.0LC - Surface Mount TVS Diode

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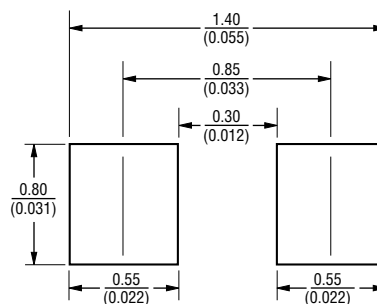
Product Dimensions

This is a molded DFN-2 package weighing approximately 1.1 mg.



Symbol	Dimensions		
	Min.	Nom.	Max.
A		1.00 (0.039)	
B		0.60 (0.024)	
C	0.51 (0.020)	0.55 (0.022)	0.60 (0.024)
C1	0.00 (0.000)	0.02 (0.001)	0.05 (0.002)
D		0.65 (0.026)	
E	0.10 (0.004)	0.25 (0.010)	0.35 (0.014)
F	0.45 (0.018)	0.60 (0.024)	0.70 (0.028)

Recommended PCB Footprint



Typical Part Marking

CDDFN2-T5.0LC L

How to Order

CD DFN2 - T 5.0 LC

Common Diode _____

Chip Diode _____

Package _____

DFN2 = DFN-2 Package

Model _____

Transient Voltage Suppressor

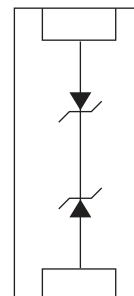
Working Peak Reverse Voltage _____

5.0 = 5.0 V_{RWM} (Volts)

Suffix _____

LC = Low Capacitance Bidirectional Diode

Block Diagram



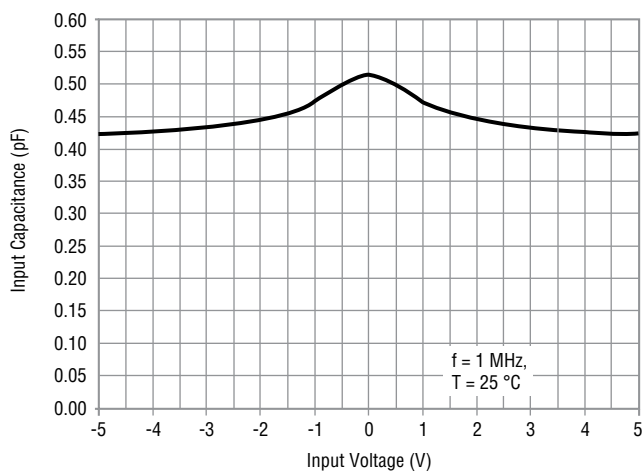
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CDDFN2-T5.0LC - Surface Mount TVS Diode

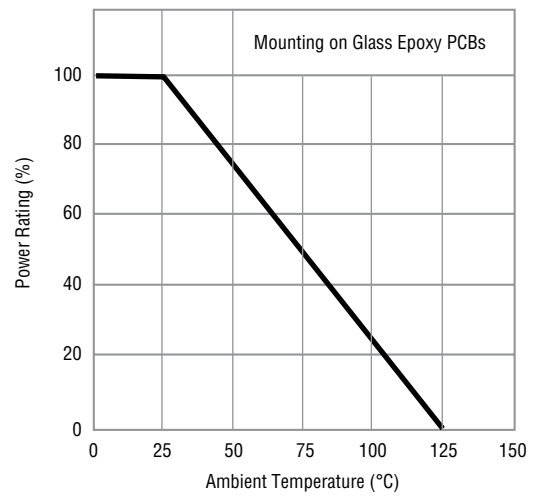
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Performance Graphs

Typical Capacitance Variation of C_{IN} vs V_{IN}



Power Derating Curve



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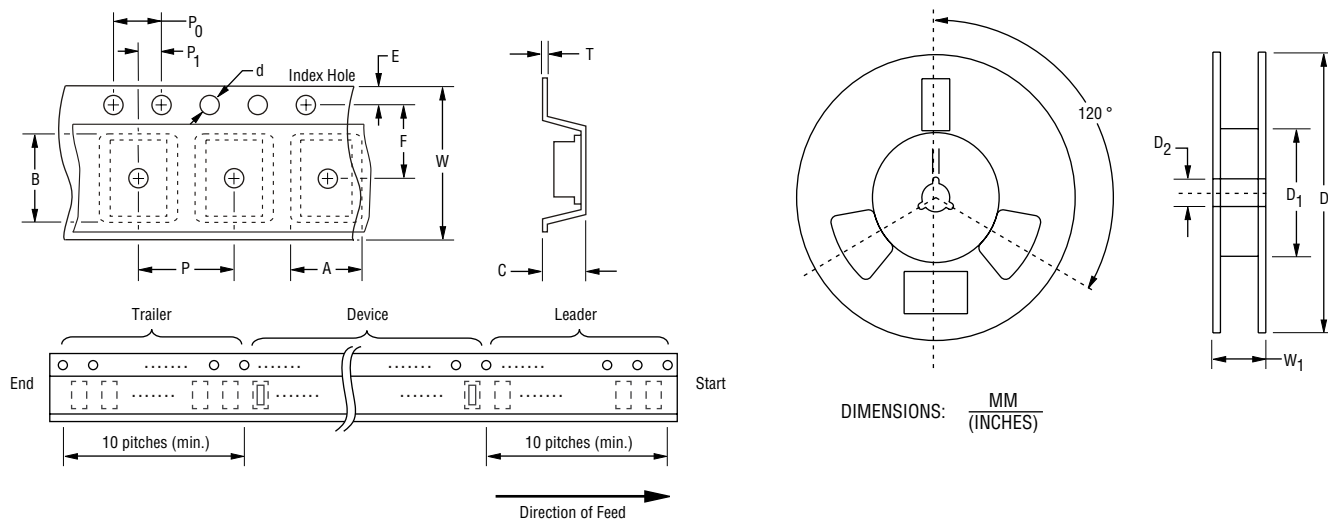
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CDDFN2-T5.0LC - Surface Mount TVS Diode

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Packaging Information

The surface mount product is packaged in an 8 mm x 4 mm tape and reel format per EIA-481 standard.



Item	Symbol	DFN-2
Carrier Width	A	$\frac{0.7 \pm 0.05}{(0.028 \pm 0.002)}$
Carrier Length	B	$\frac{1.15 \pm 0.05}{(0.045 \pm 0.002)}$
Carrier Depth	C	$\frac{0.47 \pm 0.05}{(0.019 \pm 0.002)}$
Sprocket Hole	d	$\frac{1.55 \pm 0.05}{(0.061 \pm 0.002)}$
Reel Outside Diameter	D	$\frac{180.00 \pm 2.00}{(7.087 \pm .079)}$
Reel Inner Diameter	D ₁	$\frac{60.00 \pm 1.00}{(2.362 \pm 0.039)}$
Feed Hole Diameter	D ₂	$\frac{13.10 \pm 0.20}{(0.516 \pm 0.008)}$
Sprocket Hole Position	E	$\frac{1.75 \pm 0.10}{(0.069 \pm 0.004)}$
Punch Hole Position	F	$\frac{3.50 \pm 0.05}{(0.138 \pm 0.002)}$
Punch Hole Pitch	P	$\frac{2.00 \pm 0.10}{(0.079 \pm 0.004)}$
Sprocket Hole Pitch	P ₀	$\frac{4.00 \pm 0.10}{(0.157 \pm 0.004)}$
Embossment Center	P ₁	$\frac{2.00 \pm 0.05}{(0.079 \pm 0.002)}$
Overall Tape Thickness	T	$\frac{0.20 \pm 0.05}{(0.008 \pm 0.002)}$
Tape Width	W	$\frac{8.00 \pm 0.10}{(0.315 \pm 0.004)}$
Reel Width	W ₁	$\frac{11.60 \pm 1.00}{(0.457 \pm 0.039)}$
Quantity per Reel	--	12,000

REV. 02/16

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